# MA3J143, MA3J143A (MA143, MA143A)

# Silicon epitaxial planar type

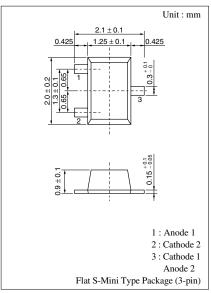
For switching circuits

#### ■ Features

- Small S-mini type package contained two elements, allowing highdensity mounting
- Two diodes are connected in series in the package

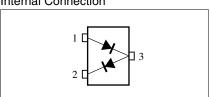
# ■ Absolute Maximum Ratings $T_a = 25$ °C

Parameter		Symbol	Rating	Unit	
Reverse current	MA3J143	$V_R$	40	V	
(DC)	MA3J143A		80		
Peak reverse	MA3J143	$V_{RM}$	40	V	
voltage	MA3J143A		80		
Forward current	Single	$I_F$	100	mA	
(DC)	Series		65		
Peak forward	Single	$I_{FM}$	200	mA	
current	Series		130		
Junction temperature		T <sub>j</sub>	150	°C	
Storage temperature		$T_{stg}$	-55 to +150	°C	



Marking Symbol

• MA3J143 : MC • MA3J143A : MP Internal Connection

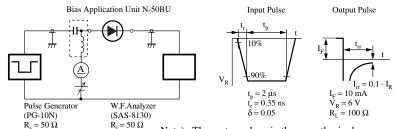


# ■ Electrical Characteristics $T_a = 25$ °C

Parameter		Symbol	Conditions	Min	Тур	Max	Unit
Reverse current (DC)	MA3J143	$I_R$	$V_R = 40 \text{ V}$			100	nA
	MA3J143A		$V_R = 80 \text{ V}$			100	
Forward voltage (DC)		$V_{\mathrm{F}}$	$I_F = 100 \text{ mA}$			1.2	V
Reverse voltage (DC)	MA3J143	$V_R$	$I_R = 100 \mu A$	40			V
	MA3J143A			80			
Terminal capacitance		C <sub>t1</sub> *1	$V_R = 0 V, f = 1 MHz$			5.5	pF
		C <sub>t2</sub> *2				3.0	pF
Reverse recovery time*	3	t <sub>rr1</sub> *1	$I_F = 10 \text{ mA}, V_R = 6 \text{ V}$		150		ns
		t <sub>rr2</sub> *2	$I_{rr} = 0.1 \cdot I_{R}, R_{L} = 100 \Omega$		9		ns

Note) \*1: Between pins 2 and 3

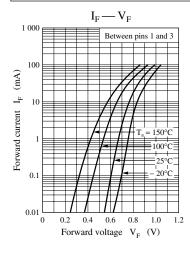
- \*2: Between pins 1 and 3
- \*3:  $t_{rr}$  measuring circuit

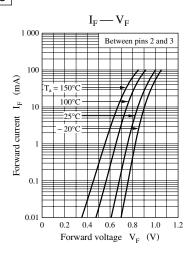


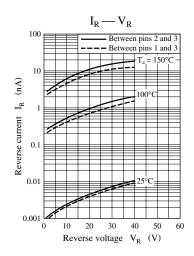
Note) The part numbers in the parenthesis show conventional part number.

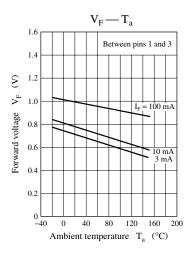
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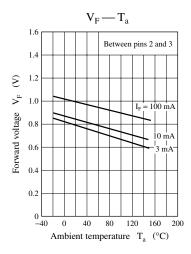
## Characteristics charts of MA3J143

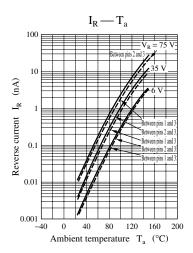


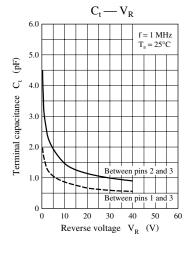


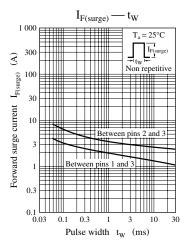






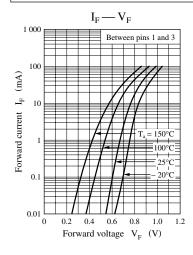


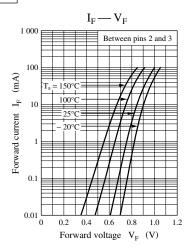


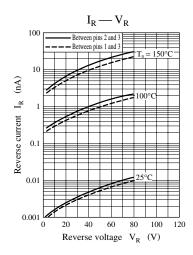


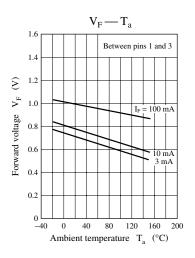
144 Panasonic

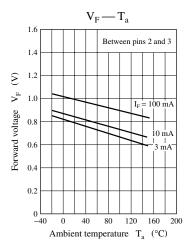
#### Characteristics charts of MA3J143A

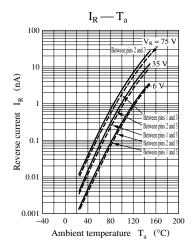


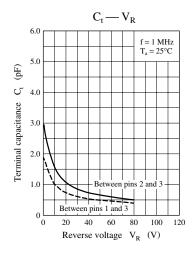


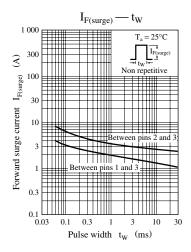












Panasonic 145

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